



RELEASE Ø



GRF5506

High Linearity Power Amplifier 0.66 to 0.72 GHz

FEATURES

- Excellent OP1dB, OIP3, ACLR and IM3 Performance
- Native Linearity Provides up to +25 dBm P_{OUT} with > 45 dBc ACLR – Without the Need for Digital Predistortion Correction
- +24.5 dBm Linear Output Power Maintained at 85 °C
- Flexible Biasing Provides Latitude for Linearity Optimization
- 190 mA Native Mode Quiescent Current Consumption
- 5 V Supply Voltage
- 50 Ω Single-ended Input and Output Impedances
- Digital Shutdown
- Rugged Design is Extremely Resilient to Mismatched Loads
- -40 to 85 °C Operating Temperature Range
- Compact 3 x 3 mm QFN-16 Package

Reference: 5.0 V / 690 MHz / 190 mA I_{CCQ}

• Gain: 28.4 dB

OIP3: 46.8 dBm @ 23 dBm P_{OUT}/tone

OP1dB: 33.3 dBmNoise Figure: 4.5 dB

APPLICATIONS

- Cellular Boosters/Repeaters
- Automotive Compensators
- Picocells/Femtocells
- Cellular DAS
- Customer Premise Equipment
- Wireless Infrastructure

DESCRIPTION

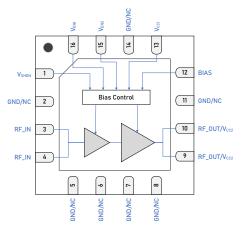
The GRF5506 is a high gain, two-stage InGaP HBT power amplifier designed to deliver excellent P1dB, ACLR and IM3 performance over the 660 to 720 MHz band. Its exceptional native linearity makes it an ideal choice for transmitter applications that typically do not employ digital predistortion correction schemes.

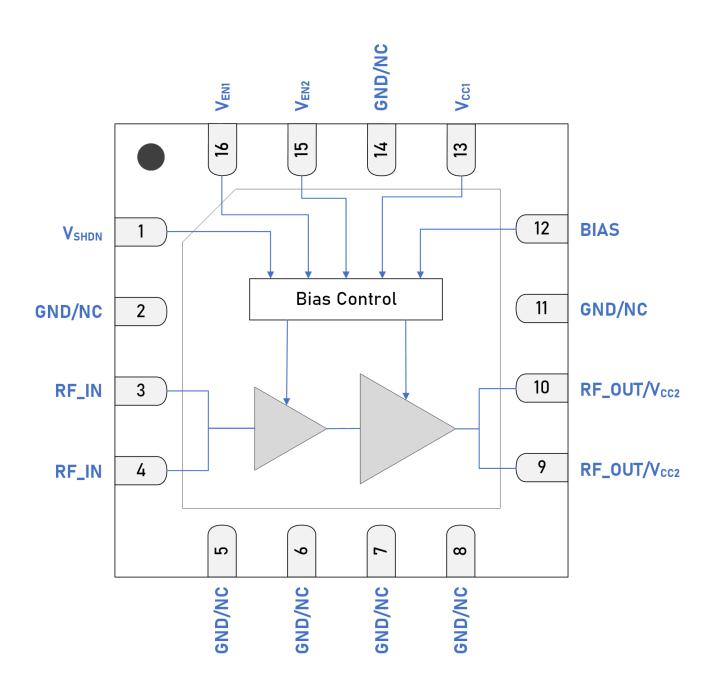
This device is part of a complete family of externally matched linear amplifiers that cover the following frequency ranges:

GRF5506: 0.66 - 0.72 GHz GRF5518: 1.8 - 1.91 GHz
GRF5507: 0.7 - 0.8 GHz GRF5519: 1.92 - 2.0 GHz
GRF5508: 0.8 - 0.9 GHz GRF5521: 2.11 - 2.17 GHz
GRF5510: 0.88 - 0.96 GHz GRF5526: 2.5 - 2.7 GHz
GRF5517: 1.7 - 1.8 GHz GRF5536: 3.4 - 3.8 GHz

Please consult with the GRF applications engineering team for custom tuning/evaluation board data.

■ BLOCK DIAGRAM





3 x 3mm QFN-16 Pin Out (Top View)





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Pin Assignments

Pin	Name	Description	Note
1	Vshdn	Digital Shutdown Pin	$V_{SHDN} \ge 1.7 \text{ V}$ (Logic HIGH) disables device. $V_{SHDN} \le 0.9 \text{ V}$ (Logic LOW) enables device.
2, 5-8, 11, 14	GND/NC	Ground or No Connect	No internal connection to die. These pins can be left unconnected, or be connected to ground (recommended). Use a via as close to the pin as possible if grounded.
3-4	RF_IN	RF Input	Internally matched 50 Ω . An external DC blocking cap must be used. Pins 3-4 tied together on system board.
9-10	RF_OUT/V _{CC2}	PA Output/Bias Voltage	Pins 9-10 tied together on system board. V _{CC2} must be applied to this pin via an RF choke.
12	Bias	Bias Circuit Supply	Connect to V _{CC2} through external resistor.
13	V _{CC1}	Bias Voltage	Connect to V _{CC1} through external resistor.
15	V _{EN2}	Enable2 Voltage Input	V_{EN2} and series resistor set I_{CCQ} for the output stage. $V_{EN2} \le 0.2$ volts disables stage 2.
16	V _{EN1}	Enable1 Voltage Input	V_{EN1} and series resistor set I_{CCQ} for the input stage. $V_{EN1} \le 0.2$ volts disables stage 1. Connecting an external de-coupling capacitor to ground is required for optimal NF performance.
PKG BASE	GND	Ground	Provides DC and RF ground for the amplifier, as well as thermal heat sink. Recommend multiple 8 mil vias beneath the package for optimal RF and thermal performance. Refer to evaluation board top layer graphic on schematic page.



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Absolute Ratings

Parameter		Symbol	Min.	Max.	Unit
Drain Voltage		Vcc		5.5	V
(50 Ω, V _{CC} = 5.0 V, CW Tone, 100% DC, T _{PKG} HEAT SINK = 25°C)		P _{IN MAX}		13	
RF Input Power (Load VSWR \leq 8:1, all phase angles $V_{CC} = 5.0 \text{ V}$, CW Tone, 100% DC, $T_{PKG \text{ HEAT SINK}} = -40 \text{ to } 85^{\circ}\text{C}$)		P _{IN MAX}		5	dBm
	g Temperature Heat Sink)	TPKG HEAT SINK	-40	85	°C
Maximum Junction Temperature (MTTF > 10 ⁶ Hours)		T _{J MAX}		170	°C
Maximum Dissipated Power (Stage 1)		P _{DISS MAX}		500	mW
Maximum Dissipated Power (Stage 2)		P _{DISS MAX}		850	mW
Electrosta	tic Discharge				
Charged I	Device Model	CDM	1000		V
Human Body Model		НВМ	500		V
Storage					
Storage Temperature		T _{STG}	-65	150	°C
Moisture	Sensitivity Level	MSL		1	-
		1	1	1	1



Caution! ESD Sensitive Device

Exceeding Absolute Maximum Rating conditions may cause permanent damage to the device.

Note: For additional information, please refer to Manufacturing Note MN-001 — Package and Manufacturing Information.



All Guerrilla RF products are provided in RoHS compliant lead (Pb)-free packaging. For additional information, please refer to the *Certificate of RoHS Compliance*.





High Linearity Power Amplifier 0.66 to 0.72 GHz

Recommended Operating Conditions

			Specification			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Power Supply Voltage	Vcc	3	5	5.5	V	
Operating Temperature (Package Heat Sink)	T _{PKG} HEAT SINK	-40		85	°C	
RF Frequency Range	F _{RF}	0.66		0.72	GHz	Typical Application Schematic Using the 0.66 to 0.72 GHz Tuning Set (Note 1)
RFIN Port Impedance	Z _{RFIN}		50		Ω	Single Ended, with 2-element Match
RFOUT Port Impedance	Zrfout		50		Ω	Single Ended, with 3-element Match

Note 1: Operation outside this range is possible, but with degraded performance of some parameters.



Nominal Operating Parameters - General

The following conditions apply unless noted otherwise: Typical Application Schematic using the 0.66 to 0.72 GHz tuning set, M5 = 1.7 k Ω , M9 = 3.3 k Ω , V_{SHDN} = LOW, V_{CC} = +4.75 to +5.25 V, I_{CCQ} = 190 mA, 50 Ω system impedance, P_{OUT} = +23 dBm, F_{TEST} = 0.66 to 0.72 GHz, T_{PKG HEAT SINK} = -40 to +85 °C. Typical values are at V_{CC} = +5.0 V, I_{CCQ} = 190 mA, P_{OUT} = +23 dBm, F_{TEST} = 0.69 GHz, T_{PKG HEAT SINK} = 25 °C. MIN/MAX specifications listed in italics are guaranteed via production test screening. All other parameters are guaranteed by design and characterization. Evaluation board losses are included within the specifications.

			Specificatio	n		
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Supply Quiescent Current	Iccq		190		mA	Iccq1 + Iccq2 . No RF Applied.
Supply Current with RF Applied	lcc		290		mA	Icc1 + Icc2 . RF Applied with Pouт = 23dBm.
Enable Current 1	lenable1		2.7		mA	V _{CC} = 5V, T _{PKG HEAT SINK} = 25 °C
Enable Current 2	I _{ENABLE2}		1.2		mA	V _{CC} = 5V, T _{PKG HEAT SINK} = 25 °C
Operating Temperature Range	TPKG HEAT SINK	-40		+85	°C	Measured on Package Heat Sink
Logic Input Low	V _{IL}	0		0.9	V	Applies to V _{SHDN} Input
Logic Input High	ViH	1.7		Vcc	V	Applies to V _{SHDN} Input
Logic Current Low	I _{IL}		3		nA	Applies to V _{SHDN} Input, V _{IL} = 0.9V.
			60			Applies to V _{SHDN} Input, V _{IH} = 1.8V.
Logic Current High	I _{IH}		280		μΑ	Applies to V_{SHDN} Input, $V_{IH} = 3.3V$.
Switching Rise Time	T _{RISE}		500		ns	Applies to V _{SHDN} Input
Switching Fall Time	T _{FALL}		2800		ns	Applies to V _{SHDN} Input
Disabled Mode	- 1	ı				
Supply Quiescent Current	Iccq-shdn		1		μА	Vcc: 5.0 V; Vshdn = HIGH
Enable Current 1	lenable1-shdn		3		mA	V _{CC} : 5.0 V; V _{SHDN} = HIGH
Enable Current 2	lenable2-shdn		1.3		mA	V _{CC} : 5.0 V; V _{SHDN} = HIGH
Thermal Data (Stage 1)		ı				
Thermal Resistance (Infrared Scan)	ΘJС		163		°C/W	On Standard Evaluation Board. No RF.
Thermal Data (Stage 2)	·					
Thermal Resistance (Infrared Scan)	Θις		98		°C/W	On Standard Evaluation Board. No RF.



GRF5506 H

High Linearity Power Amplifier 0.66 to 0.72 GHz

Nominal Operating Parameters - RF (0.66 to 0.72 GHz, 5V Operation)

The following conditions apply unless noted otherwise: Typical Application Schematic using the 0.66 to 0.72 GHz tuning set, M5 = 1.7 k Ω , M9 = 3.3 k Ω , V_{SHDN} = LOW, V_{CC} = +4.75 to +5.25 V, I_{CCQ} = 190 mA, 50 Ω system impedance, P_{OUT} = +23 dBm, F_{TEST} = 0.66 to 0.72 GHz, T_{PKG HEAT SINK} = -40 to +85 °C. Typical values are at V_{CC} = +5.0 V, I_{CCQ} = 190 mA, P_{OUT} = +23 dBm, F_{TEST} = 0.69 GHz, T_{PKG HEAT SINK} = 25 °C. MIN/MAX specifications listed in italics are guaranteed via production test screening. All other parameters are guaranteed by design and characterization. Evaluation board losses are included within the specifications.

			Specification				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition	
Small Signal Gain	S21	26.4 (Note 2)	28.4		dB	LTE 20MHz 100RB TM1.1 Downlink Waveform with 9.8dB PAR, F _{TEST} = 0.69 GHz, T _{PKG HEAT SINK} = 25 °C, V _{CC} = 5 V, P _{IN} = -25 dBm.	
Standby Mode Gain	S21 _{STBY}		-45		dB	Disabled Mode, LTE 20MHz 100RB TM1.1 Downlink Waveform with 9.8dl PAR, V _{SHDN} = HIGH, P _{IN} = 0 dBm.	
Input Return Loss	S11		> 14		dB	F _{RF} = 0.66 to 0.72 GHz	
Output Return Loss	S22		> 5		dB	F _{RF} = 0.66 to 0.72 GHz	
Reverse Isolation	S12		> 45		dB	F _{RF} = 0.66 to 0.72 GHz	
Evaluation Board Noise Figure	NF		4.5		dB		
Output 3rd Order Intercept	OIP3		46.8		dBm	+23 dBm P _{OUT} per Tone at 600 kHz Spacing	
Output 1 dB Compression Power	OP1dB	31.8	33.3		dBm	Sine wave input, $V_{CC} = 5V$,	
		(Note 2)				T PKG HEAT SINK = 25 °C	
Adjacent Channel Leakage Ratio	ACLR			-45	dBc	Pout = +23 dBm, LTE 20MHz 100RB TM1.1 Downlink Waveform with 9.8dB PAR, F _{TEST} = 0.69 GHz, T _{PKG HEAT SINK} = 25 °C, V _{CC} = 5 V.	

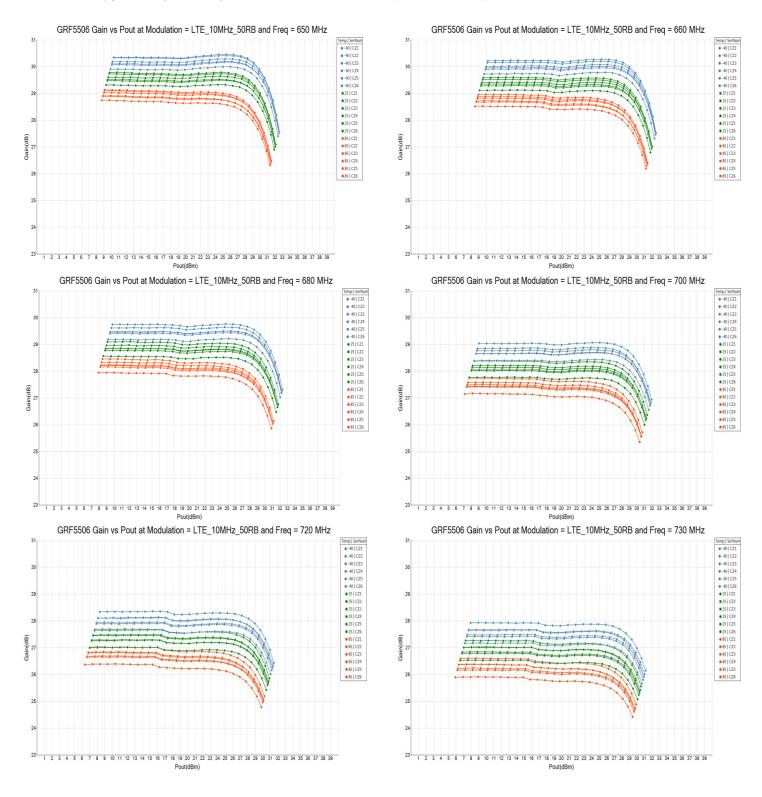
Note 2: MIN/MAX limits defined using *modelled estimates* that account for part-to-part variations and expected process spreads. As additional production lots are fabricated, accumulated test data will be used to refine the MIN/MAX limits.

Typical Operating Curve Conditions

The following conditions apply unless noted otherwise: Typical Application Schematic using the 0.66 to 0.72 GHz tuning set, M5 = 1.7 k Ω , M9 = 3.3 k Ω , V_{SHDN} = LOW, V_{CC} = 5 V, I_{CCQ} = 190 mA, 50 Ω system impedance, F_{TEST} = 0.66 to 0.72 GHz, T_{PKG HEAT SINK} = 25 °C. Evaluation board losses are included within the plots.

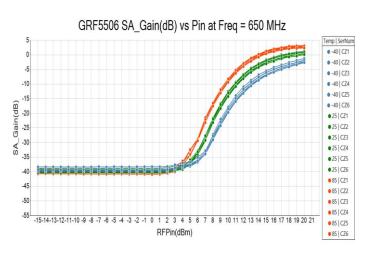


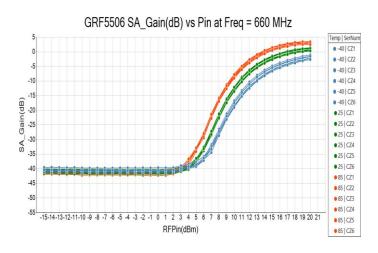
GRF5506 Typical Operating Curves: Gain vs. Pout (9.6 dB PAR)

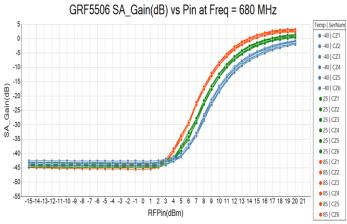


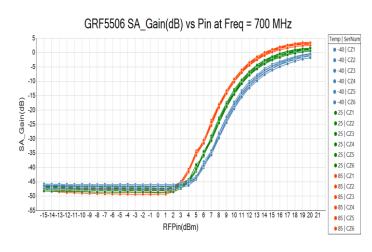


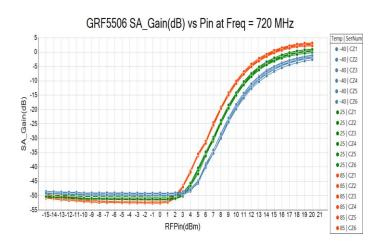
GRF5506 Typical Operating Curves: Gain vs. P_{IN} (Shutdown Mode, V_{SHDN} = 3.3V, 9.6dB PAR)

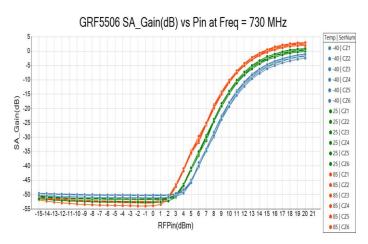






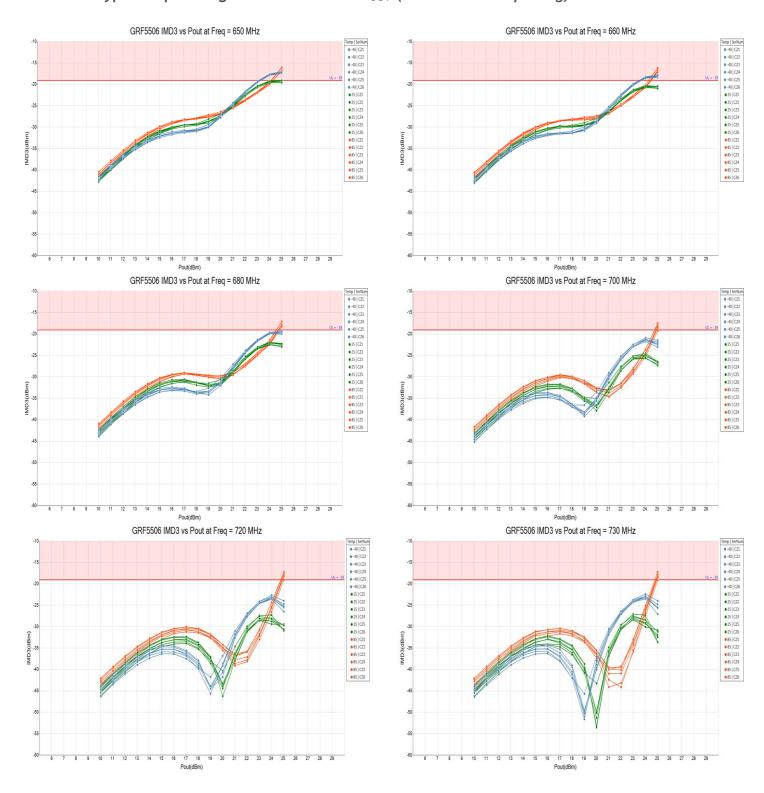






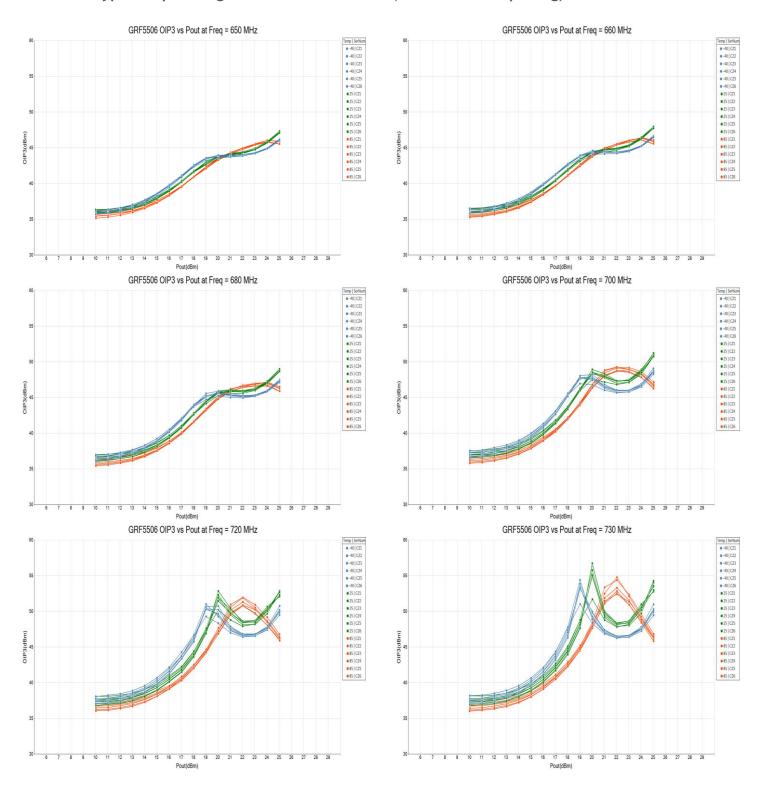


GRF5506 Typical Operating Curves: IMD3 vs. Pout (600kHz Tone Spacing)



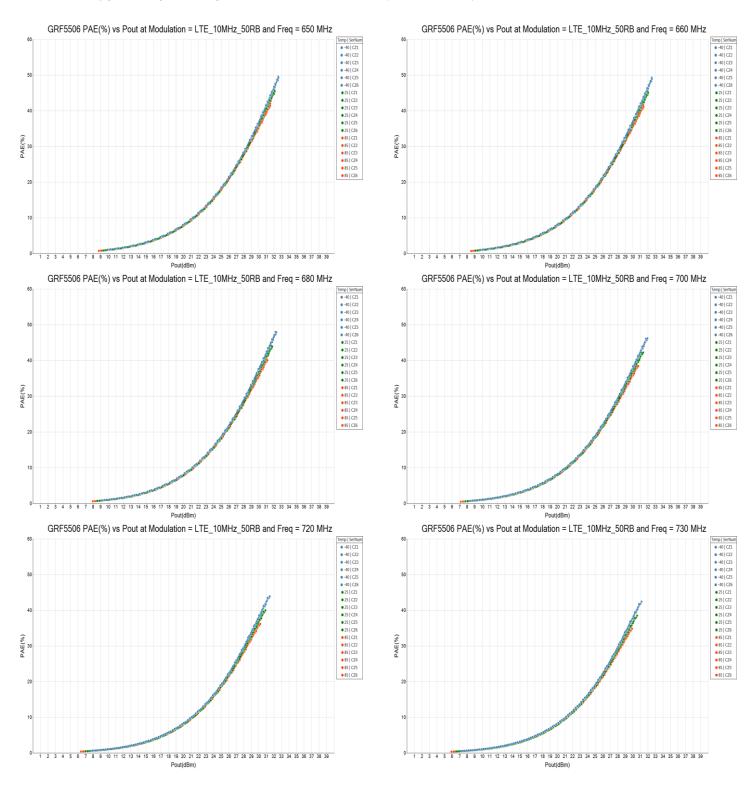


GRF5506 Typical Operating Curves: OIP3 vs. Pout (600kHz Tone Spacing)



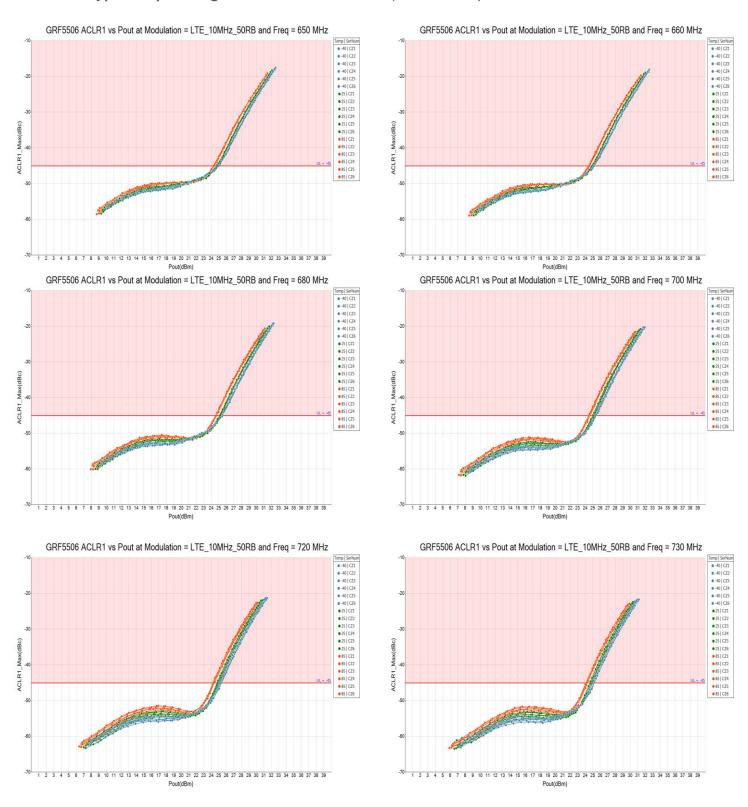


GRF5506 Typical Operating Curves: PAE vs. Pout (9.6 dB PAR)



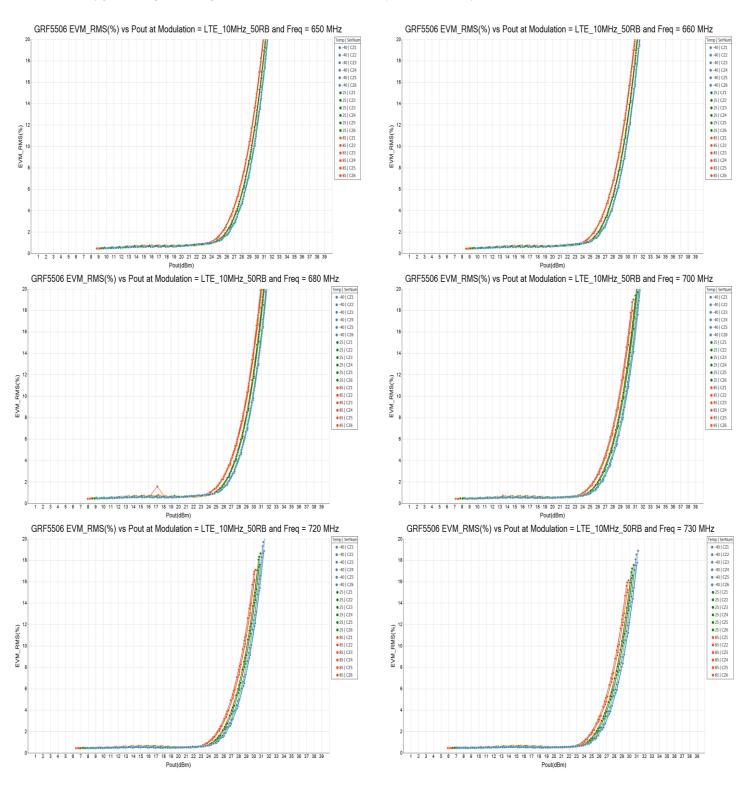


GRF5506 Typical Operating Curves: ACLR vs. Pout (9.6 dB PAR)



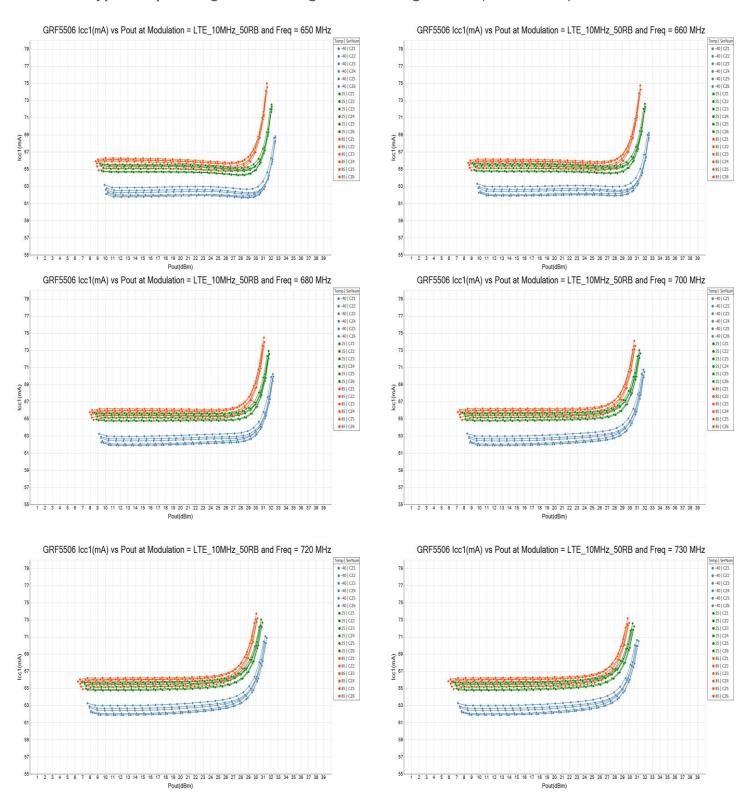


GRF5506 Typical Operating Curves: EVM vs. Pout (9.6 dB PAR)



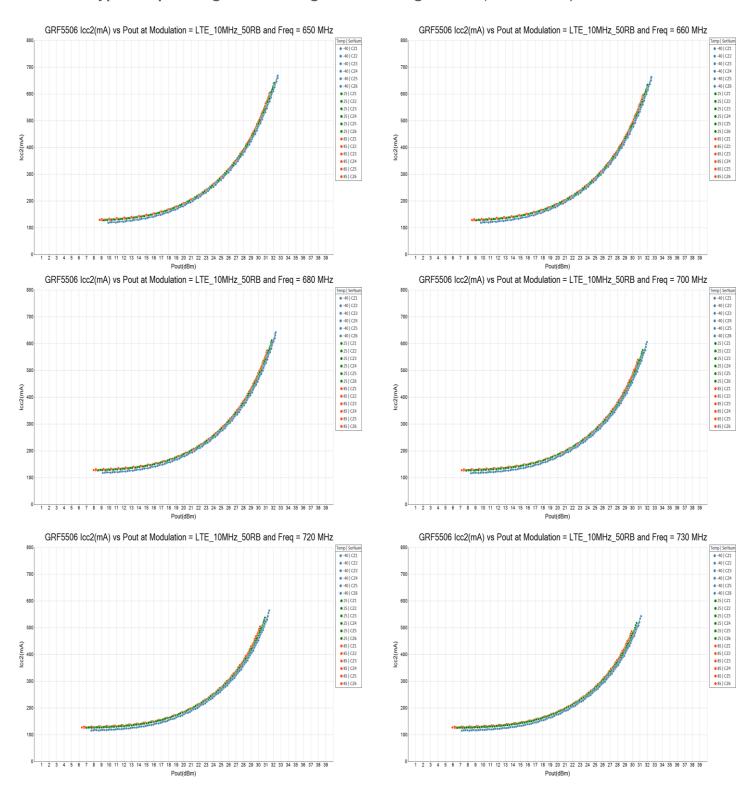


GRF5506 Typical Operating Curves: Stage1 Icc vs. Stage2 Pout (9.6 dB PAR)





GRF5506 Typical Operating Curves: Stage2 Icc vs. Stage2 Pout (9.6 dB PAR)



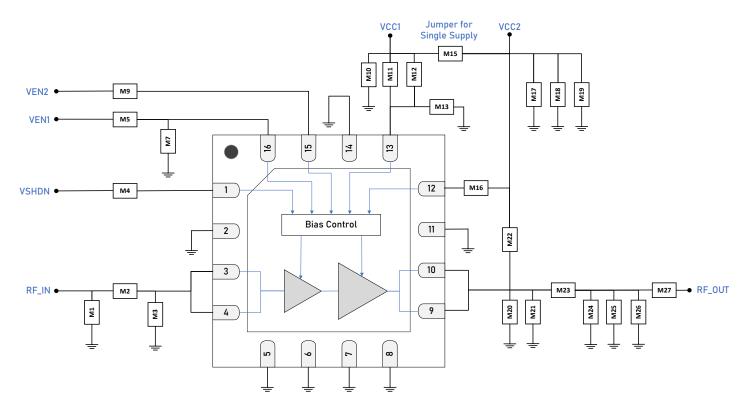




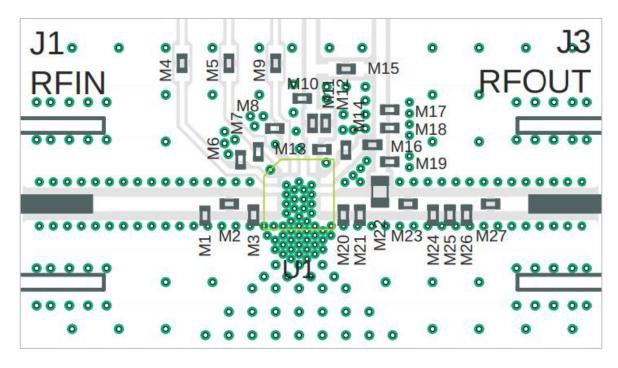
Truth Table

Pin	Logic	Condition
	LOW	Full Operation
V _{SHDN}	HIGH	All Amplifiers Off
	LOW	Stage 1 Amplifier Off
V _{EN1}	HIGH	Stage 1 Amplifier On
	LOW	Stage 2 Amplifier Off
V _{EN2}	HIGH	Stage 2 Amplifier On





GRF5506 Application Schematic



GRF5506 Evaluation Board Assembly Diagram

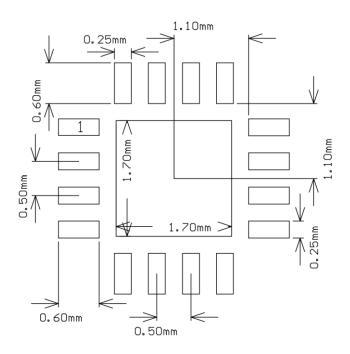


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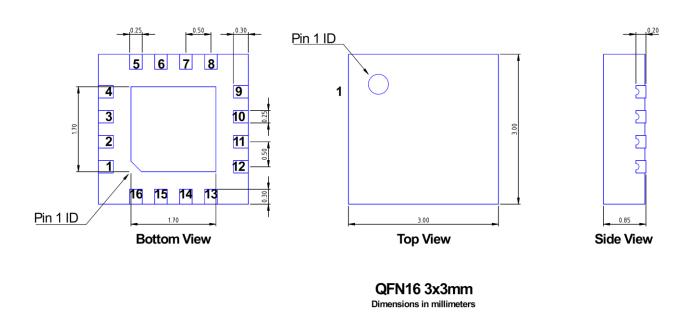
GRF5506 Evaluation Board Assembly Diagram Reference

Component	Туре	Manufacturer	Family	Value	Package Size	Substitutio
M1	Inductor	Murata	LQG	10.0 nH	0402	ok
M2	Capacitor	Murata	GJM	8.2 pF	0402	ok
M3	DNP					
M4	Resistor	Various	5%	0 Ohm	0402	ok
M5	Resistor	Various	5%	1.7 kΩ	0402	ok
M7	Capacitor	Murata	GRM	100 pF	0402	ok
M9	Resistor	Various	5%	3.3 kΩ	0402	ok
M10	Capacitor	Murata	GRM	0.1 μF	0402	ok
M11	Inductor	Murata	LQG	8.2 nH	0402	ok
M12	DNP					
M13	DNP					
M15	Resistor	Various	5%	0 Ohm	0402	ok
M16	Resistor	Various	5%	0 Ohm	0402	ok
M17	DNP	_	_	_	0402	ok
M18	Capacitor	Murata	GRM	10 μF	0402	ok
M19	Capacitor	Murata	GRM	100 pF	0402	ok
M20	DNP					
M21	DNP					
M22	Inductor: High Q	Murata	LQW	24 nH	0603	ok
M23	Inductor: High Q	Murata	LQW	3.2 nH	0402	ok
M24	Capacitor	Murata	GJM	10 pF	0402	ok
M25	DNP					
M26	DNP					
M27	Capacitor	Murata	GJM	47 pF	0402	ok
Evaluation Board	QFN16-30-24-B					





3 x 3 mm QFN-16 Suggested PCB Footprint (Top View)



3 x 3 mm QFN-16 Package Dimensions



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Package Marking Diagram



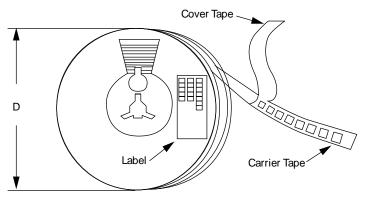
Line 1 "XXXX" = PART NUMBER

Line 2 "YY" = YEAR and "WW" = WEEK that the part was assembled.

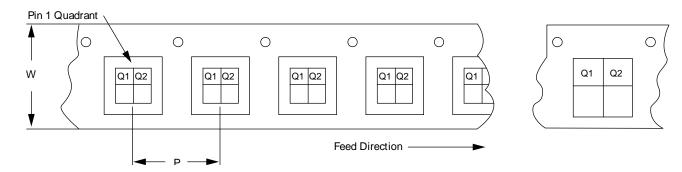
Tape and Reel Information

Guerrilla RF's tape and reel specification complies with Electronics Industries Association (EIA) standards for "Embossed Carrier Tape of Surface Mount Components for Automatic Handling" (reference EIA-481). See the following page for the Tape and Reel Specification and Device Package Information table, which includes units per reel.

Devices are loaded with pins down into the carrier pocket with protective cover tape and reeled onto a plastic reel. Each reel is packaged in a cardboard box. There are product labels on the reel, the protective ESD bag and the outside surface of the box.



Tape and Reel Packaging with Reel Diameter Noted (D)



Carrier Tape Width (W), Pitch (P), Feed Direction and Pin 1 Quadrant Information



High Linearity Power Amplifier 0.66 to 0.72 GHz

RELEASE Ø DATASHEET

Tape and Reel Specification and Device Package Information

	Package				Carrier Tape	Reel		
Туре	Dimensions (mm)	Leads	Weight (mg)	Width (W) (mm)	Pocket Pitch (P) (mm)	Pin 1 Quadrant	Diameter (D) (Inches)	Units per Reel
QFN	2.0 x 2.0 x 0.50	12	7	8	4	Q1	7	2500
QFN	3.0 x 3.0 x 0.85	16	24	12	8	Q1	7	1500
DFN	1.5 x 1.5 x 0.45	6	4	8	4	Q1	7	2500
DFN	2.0 x 2.0 x 0.75	8	12	8	4	Q1	7	2500
LFM	3.5 x 3.5 x 0.75	See note	TBD	12	8	Q2	7	1500
LFM	4.0 x 4.0 x 0.75	See note	TBD	12	8	Q2	7	1500

Note: Lead count may vary. Reference applicable product data sheet.



High Linearity Power Amplifier 0.66 to 0.72 GHz

RELEASE Ø DATASHEET

Revision History

Revision Date	Description of Change
October 14, 2020	Release Ø update. Converted format to new template. Added typcial operating curves.
October 15, 2020	Corrected I _{ENABLE} values.





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Datasheet Classifications

Data Sheet Status	Notes
Advance	S-parameter and NF data based on EM simulations for the fully packaged device using foundry-supplied transistor S-parameters. Linearity estimates based on device size, bias condition and experience with related devices.
Preliminary	All data based on evaluation board measurements taken within the Guerrilla RF Applications Lab. Any MIN/MAX limits represented within the datasheet are based solely on <i>estimated</i> part-to-part variations and process spreads. All parametric values are subject to change pending the collection of additional data.
Release Ø	All data based on measurements taken with <i>production-released</i> material. TYP values are based on a combination of ATE and bench-level measurements, with MIN/MAX limits defined using <i>modelled estimates</i> that account for part-to-part variations and expected process spreads. Although unlikely, future refinements to the TYP/MIN/MAX values may be in order as multiple lots are processed through the factory.
Release A-Z	All data based on measurements taken with production-released material derived from multiple lots which have been fabricated over an extended period of time. MIN/MAX limits may be refined over previous releases as more statistically significant data is collected to account for process spreads.

Information in this datasheet is specific to the Guerrilla RF, Inc. ("Guerrilla RF") product identified.

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